SCT4045DW7HR

Automotive Grade N-channel SiC power MOSFET Datasheet

V_{DSS}	750V
$R_{DS(on)}$ (Typ.)	45mΩ
I_D *1	31A
P_D	93W

● Features

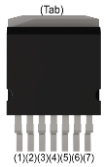
1) Qualified to AEC-Q101
2) Low on-resistance
3) Fast switching speed
4) Fast reverse recovery
5) Easy to parallel
6) Simple to drive
7) Pb-free lead plating ; RoHS compliant

● Application

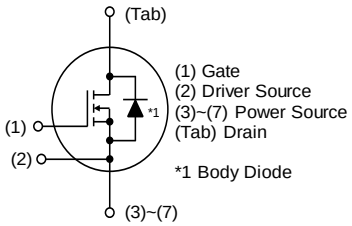
・Automobile
・Switch mode power supplies

●Outline

TO-263-7L



●Inner circuit



Please note Driver Source and Power Source are not exchangeable. Their exchange might lead to malfunction.

●Packaging specifications

Type	Packing	Embossed tape
	Reel size (mm)	330
	Tape width (mm)	24
	Basic ordering unit (pcs)	1000
	Taping code	TL
	Marking	SCT4045DW7

●Absolute maximum ratings (T_{vj} = 25°C unless otherwise specified)

Parameter			Symbol	Value	Unit
Drain - source voltage			V_{DSS}	750	V
Continuous drain and source current	$V_{GS} = V_{GS_on}$	T_c = 25°C	I_D, I_S *1	31	A
		T_c = 100°C		22	A
Pulsed drain current	$V_{GS} = V_{GS_on}$	T_c = 25°C	$I_{D,pulse}$ *2	61	A
Body diode pulsed forward current		T_c = 25°C, V_{GS} = 0 V	$I_{S,pulse}$ *1,*3	31	A
Body diode surge forward current			$I_{S,pulse}$ *1,*4	61	A
Gate - source voltage (DC)			V_{GSS_DC}	-4 to +21	V
Gate - source surge voltage (t_{surge} < 300ns)			V_{GSS_surge} *5	-4 to +23	V
Recommended turn-on gate - source drive voltage			V_{GS_on} *6	+15 to +18	V
Recommended turn-off gate - source drive voltage			V_{GS_off}	0	V
Virtual junction temperature			T_{vj}	175	°C
Range of storage temperature			T_{stg}	-40 to +175	°C

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●Electrical characteristics (T_{vj} = 25°C unless otherwise specified)

Parameter	Symbol	Conditions	Values			Unit
			Min.	Typ.	Max.	
Drain - Source breakdown voltage	$V_{(BR)DSS}$	V_{GS} = 0 V, I_D = 5.3mA T_{vj} = 25°C	750	-	-	V
Zero Gate voltage Drain current	I_{DSS}	V_{GS} = 0 V, V_{DS} =750V T_{vj} = 25°C T_{vj} = 150°C	- -	1 10	80 -	μA
Gate - Source leakage current	I_{GSS+}	V_{GS} = +21V , V_{DS} = 0V	-	-	100	nA
Gate - Source leakage current	I_{GSS-}	V_{GS} = -4V , V_{DS} = 0V	-	-	-100	nA
Gate threshold voltage	$V_{GS(th)}$ *7	V_{DS} = 10V, I_D = 8.89mA	2.8	-	4.8	V
Static Drain - Source on - state resistance	$R_{DS(on)}$ *8	V_{GS} = 18V, I_D = 17A T_{vj} = 25°C T_{vj} = 150°C	- -	45 77	59 -	mΩ
Gate input resistance	R_G	f = 1MHz, open drain	-	4	-	Ω

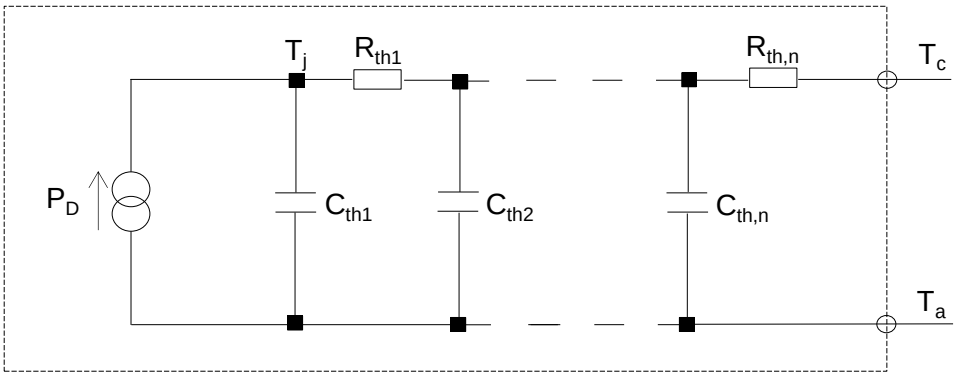
●Thermal resistance

Parameter	Symbol	Values			Unit
		Min.	Typ.	Max.	
Thermal resistance, junction - case	R_{thJC} *9	-	1.2	1.6	K/W

●Typical Transient Thermal Characteristics

Symbol	Value	Unit
R_{th1}	8.9×10^{-2}	K/W
R_{th2}	5.7×10^{-1}	
R_{th3}	5.3×10^{-1}	

Symbol	Value	Unit
C_{th1}	5.3×10^{-4}	Ws/K
C_{th2}	2.8×10^{-3}	
C_{th3}	1.5×10^{-1}	



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●**Electrical characteristics** (T_{vj} = 25°C unless otherwise specified)

Parameter		Symbol	Conditions	Values			Unit
				Min.	Typ.	Max.	
Transconductance		g_{fs} *8	V_{DS} = 10V, I_D = 17A	-	9.3	-	S
Input capacitance		C_{iss}	V_{GS} = 0V	-	1460	-	pF
Output capacitance		C_{oss}	V_{DS} = 500V	-	69	-	
Reverse transfer capacitance		C_{rss}	f = 1MHz	-	5	-	
Effective output capacitance, energy related		$C_{o(er)}$	V_{GS} = 0V V_{DS} = 0V to 500V	-	90	-	pF
Total Gate charge		Q_g *8	V_{DS} = 500V I_D = 17A V_{GS} = 18V See Fig. 1-1, 1-2.	-	63	-	nC
Gate - Source charge		Q_{gs} *8		-	14	-	
Gate - Drain charge		Q_{gd} *8		-	19	-	
Turn - on delay time		$t_{d(on)}$ *8	V_{DS} = 500V I_D = 17A V_{GS} = +18V / 0V R_G = 3.3Ω, L = 250μH E_{on} includes diode reverse recovery L_σ = 50nH, C_σ = 10pF See Fig. 2-1, 2-2, 2-3.	-	5.1	-	ns
Rise time		t_r *8		-	16	-	
Turn - off delay time		$t_{d(off)}$ *8		-	27	-	
Fall time		t_f *8		-	10	-	
Turn - on switching loss		E_{on} *8		-	112	-	μJ
Turn - off switching loss		E_{off} *8		-	17	-	
Short-circuit withstand time	$V_{GS(on)}$ = +15V	t_{sc} *10	$V_{DS} \leq$ 400V $V_{DS,peak} \leq$ 750V $T_{vj(start)}$ = 25°C R_G = 2.2Ω	-	12.0	-	μs
	$V_{GS(on)}$ = +18V			-	11.5	-	μs

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●**Body diode electrical characteristics** (Source-Drain) (T_{vj} = 25°C unless otherwise specified)

Parameter	Symbol	Conditions	Values			Unit
			Min.	Typ.	Max.	
Forward voltage	V_{SD} *8	V_{GS} = 0V, I_S = 17A	-	3.3	-	V
Reverse recovery time	t_{rr} *8	I_F = 17A V_R = 500V di/dt = 2900A/μs L_σ = 50nH, C_σ = 10pF See Fig. 3-1, 3-2.	-	9.3	-	ns
Reverse recovery charge	Q_{rr} *8		-	89	-	nC
Peak reverse recovery current	I_{rrm} *8		-	19	-	A

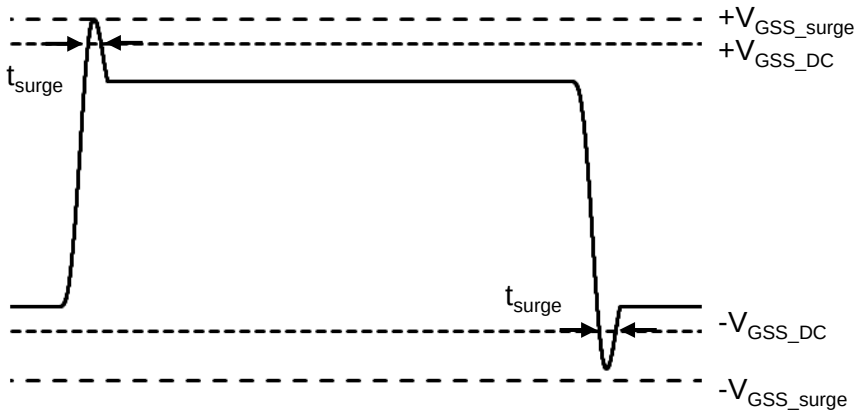
*1 Limited by maximum T_{vj} and for Max. R_{thJC}.

*2 Pulse width and duty cycle are limited by $T_{vj,max}$.

*3 Only for body-diode, Repetitive pulse, PW ≤ 1.5μs, Duty cycle ≤ 5%

*4 When used as a protective function, PW ≤ 10μs

*5 Example of acceptable V_{GS} waveform



Please note especially when using driver source that V_{GSS_surge} must be in the range of absolute maximum rating.

*6 Please be advised not to use SiC-MOSFETs with V_{GS} below 10V as doing so may cause thermal runaway.

*7 Tested after applying V_{GS} = 21V for 100ms.

*8 Pulsed

*9 Measured conformable to JESD51-14.

See the application note "rthjc_measurement_and_usage_an-e.pdf". Link

URL: https://fscdn.rohm.com/en/products/databook/applinote/discrete/common/rthjc_measurement_and_usage_an-e.pdf

*10 The value is based on TO-247 package. Single Pulsed.

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●Electrical characteristic curves

Fig.1 Power Dissipation Derating Curve

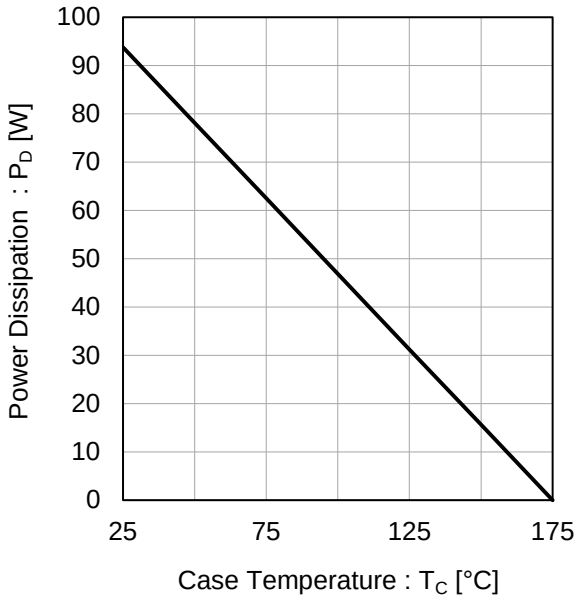


Fig.2 Maximum Safe Operating Area

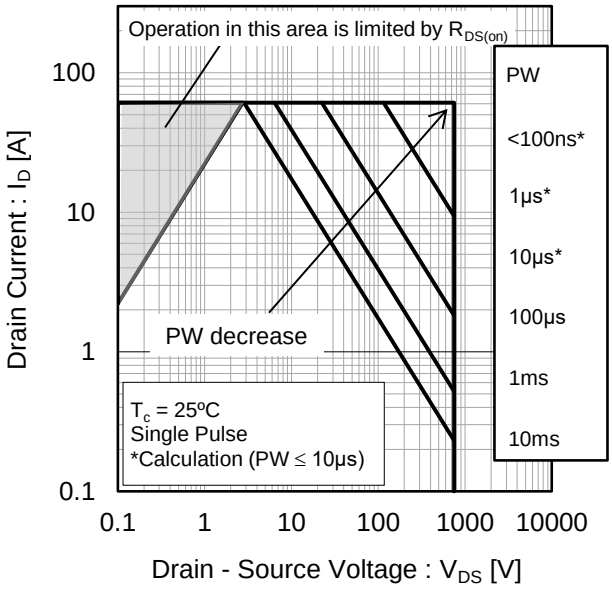
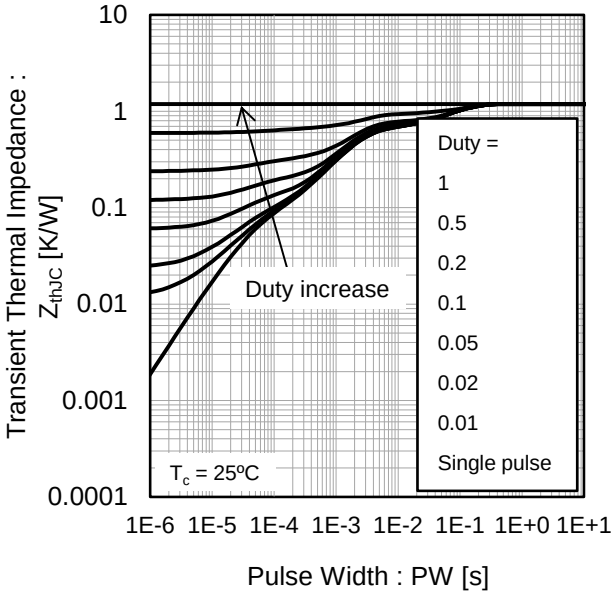


Fig.3 Typical Transient Thermal Impedance vs. Pulse Width



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●Electrical characteristic curves

Fig.4 T_{vj} = 25ºC Typical Output Characteristics

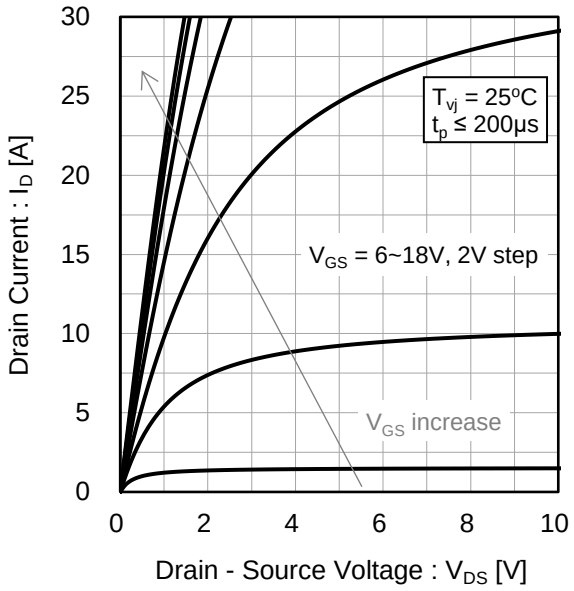
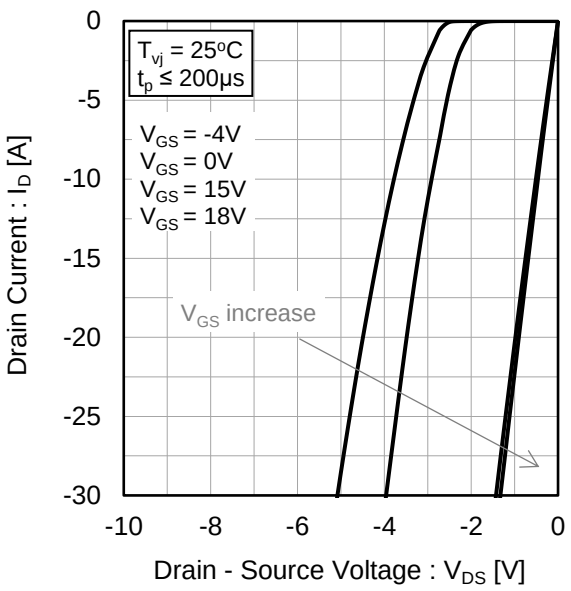


Fig.5 T_{vj} = 25ºC 3rd Quadrant Characteristics



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●Electrical characteristic curves

Fig.6 T_{vj} = 150ºC Typical Output Characteristics

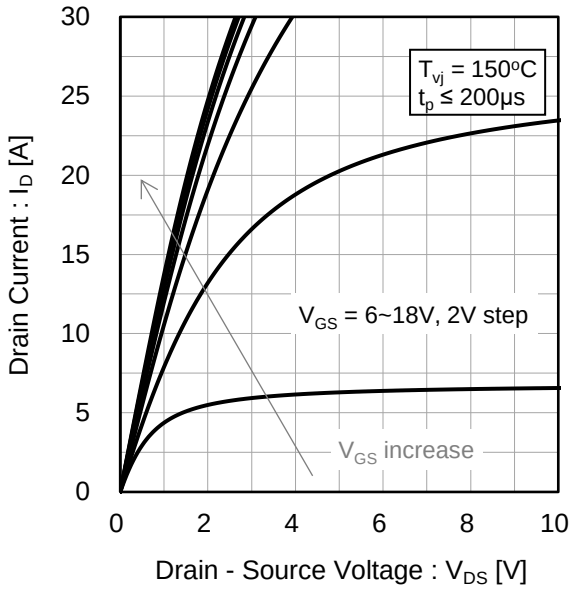


Fig.7 T_{vj} = 150ºC 3rd Quadrant Characteristics

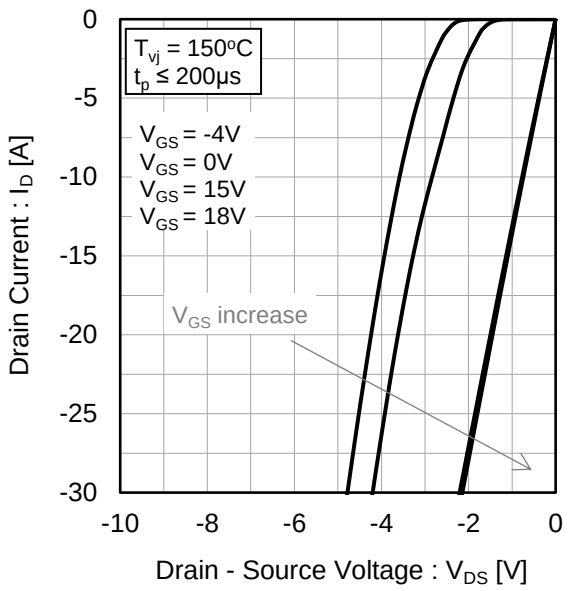
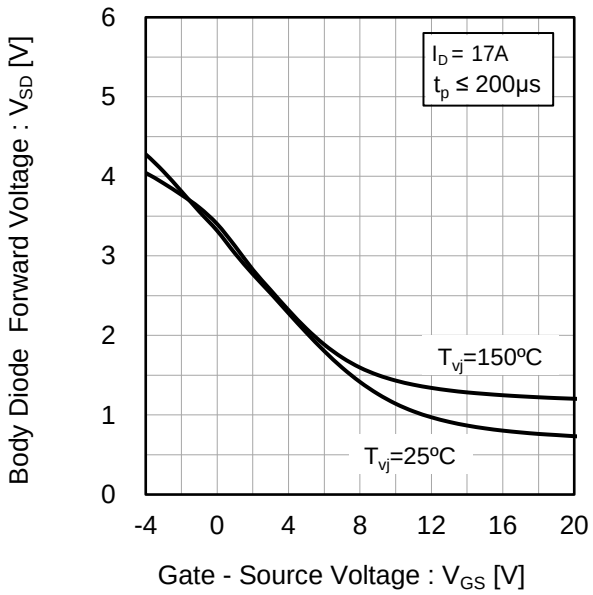


Fig.8 Body Diode Forward Voltage vs. Gate - Source Voltage



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●Electrical characteristic curves

Fig.9 Typical Transfer Characteristics (I)

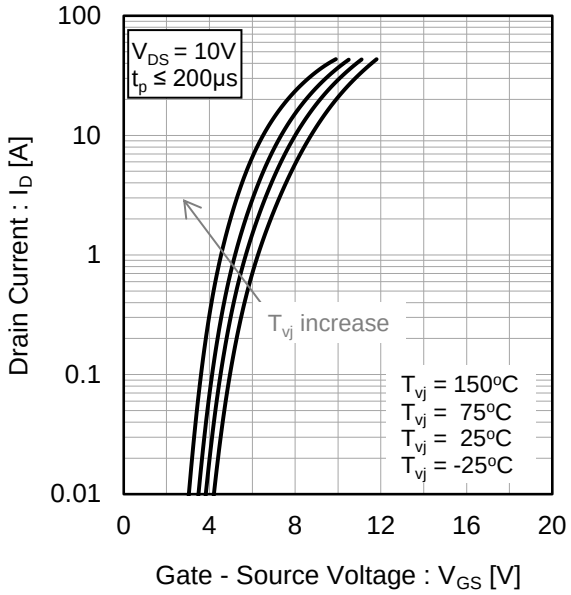


Fig.10 Typical Transfer Characteristics (II)

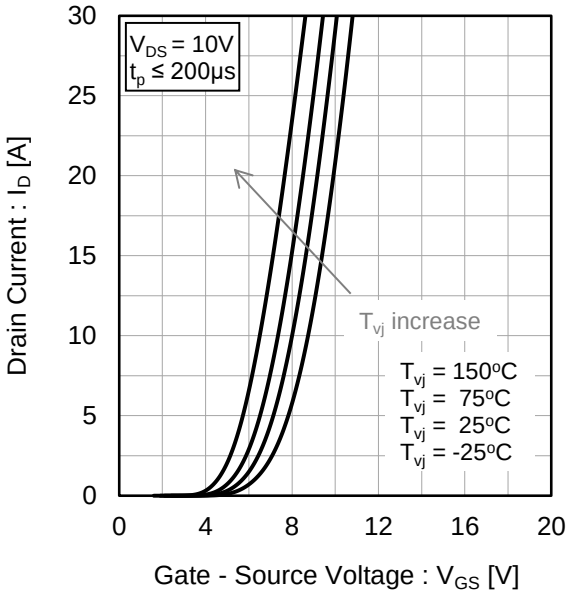


Fig.11 Gate Threshold Voltage vs. Virtual Junction Temperature

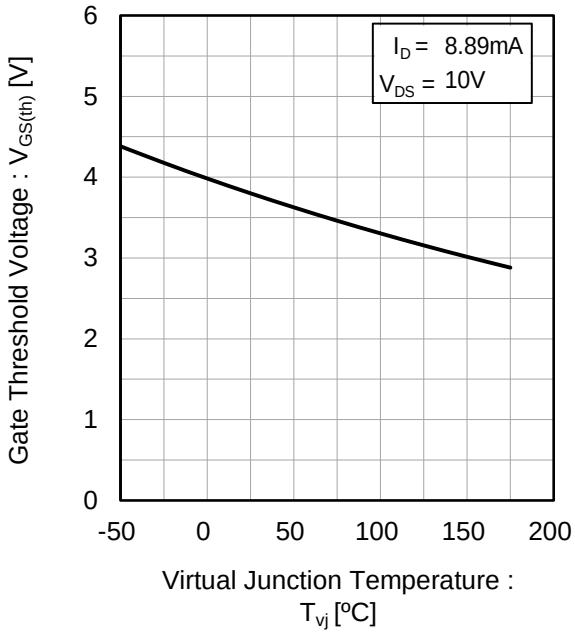
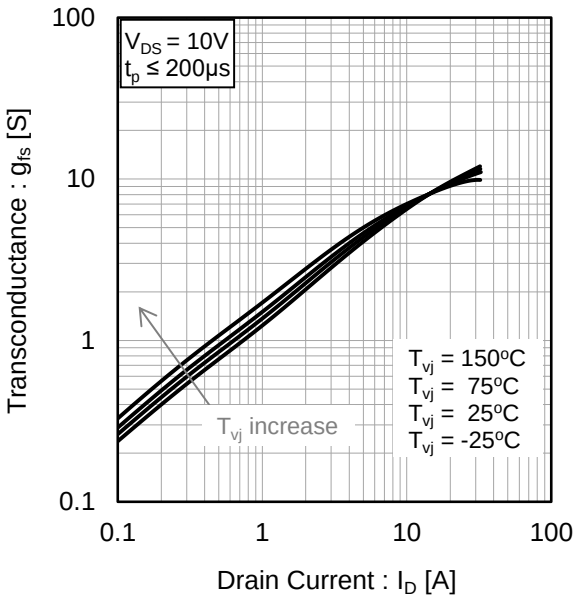


Fig.12 Transconductance vs. Drain Current



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●Electrical characteristic curves

Fig.13 Static Drain - Source On - State Resistance vs. Gate - Source Voltage

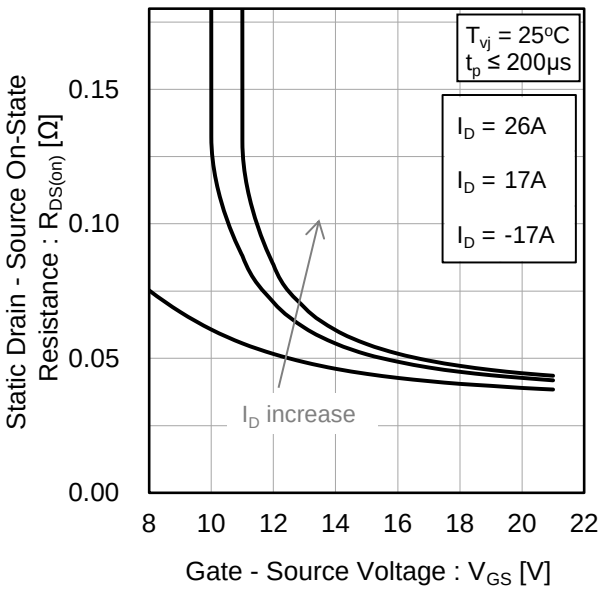


Fig.14 Static Drain - Source On - State Resistance vs. Virtual Junction Temperature

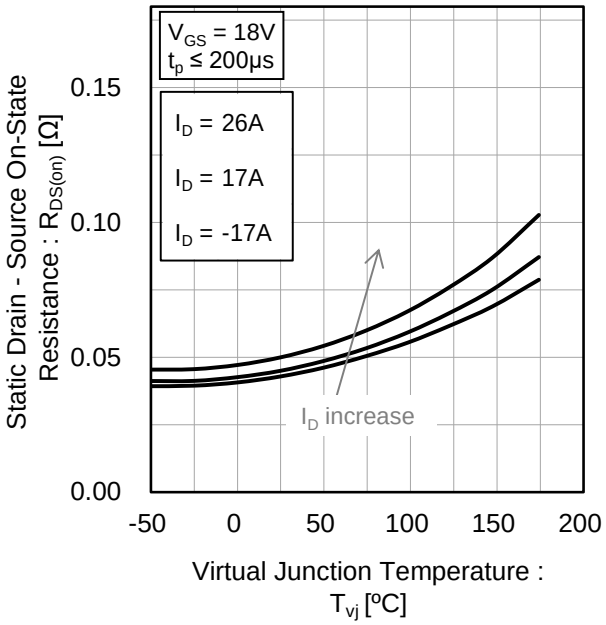


Fig.15 Static Drain - Source On - State Resistance vs. Drain Current

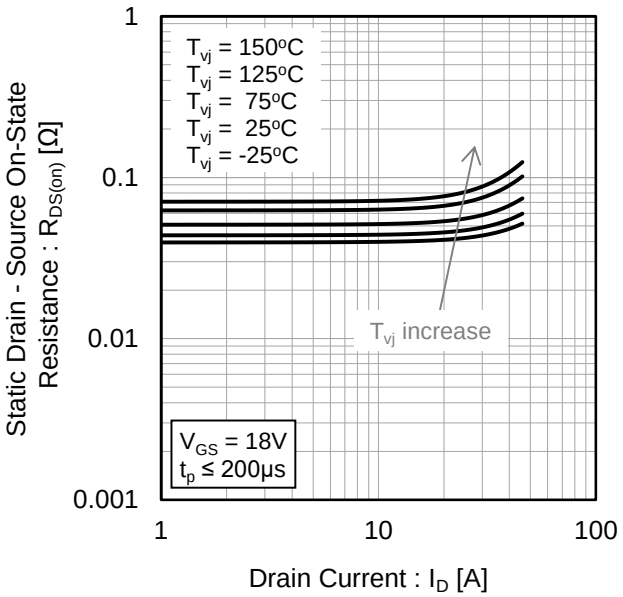
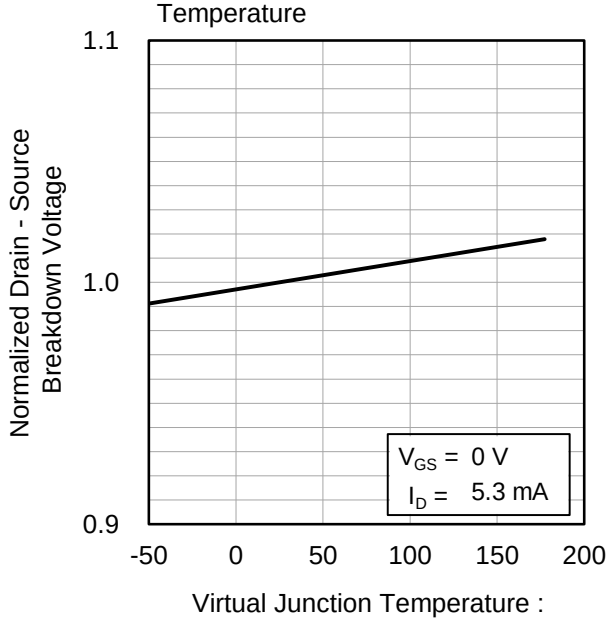


Fig.16 Normalized Drain - Source Breakdown Voltage vs. Virtual Junction Temperature



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●Electrical characteristic curves

Fig.17 Typical Capacitance vs. Drain - Source Voltage

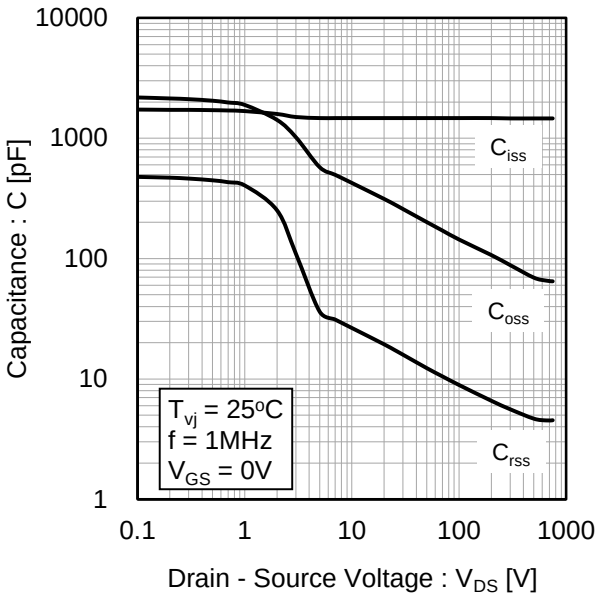


Fig.18 C_{oss} Stored Energy vs. Drain - Source Voltage

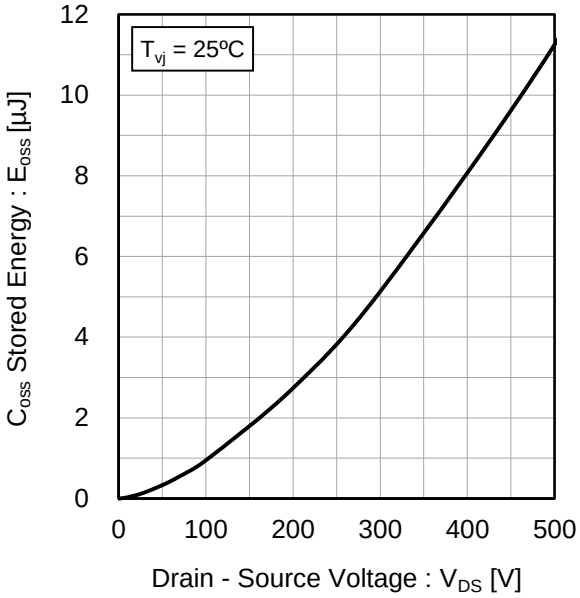
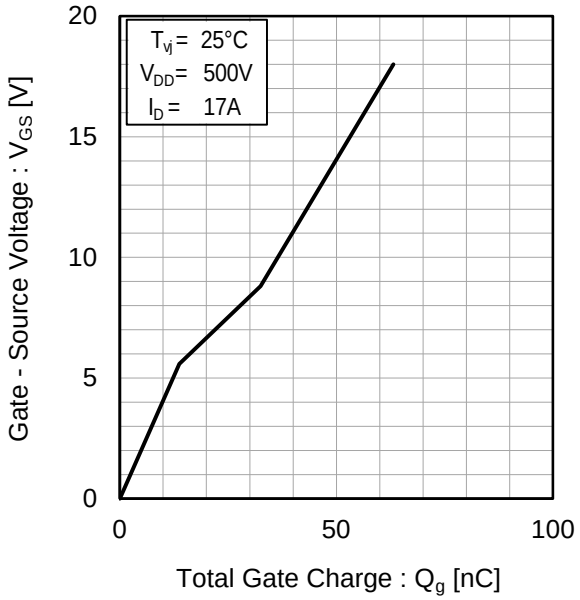


Fig.19 Dynamic Input Characteristics



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●Electrical characteristic curves

Fig.20 Typical Switching Time vs. External Gate Resistance

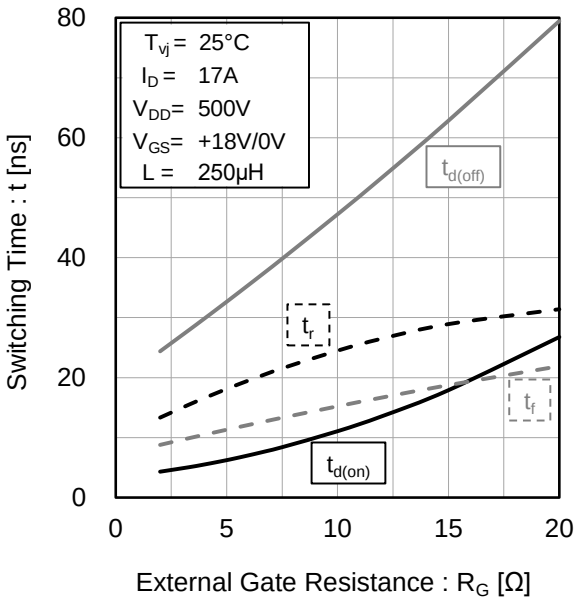


Fig.21 Typical Switching Loss vs. Drain - Source Voltage

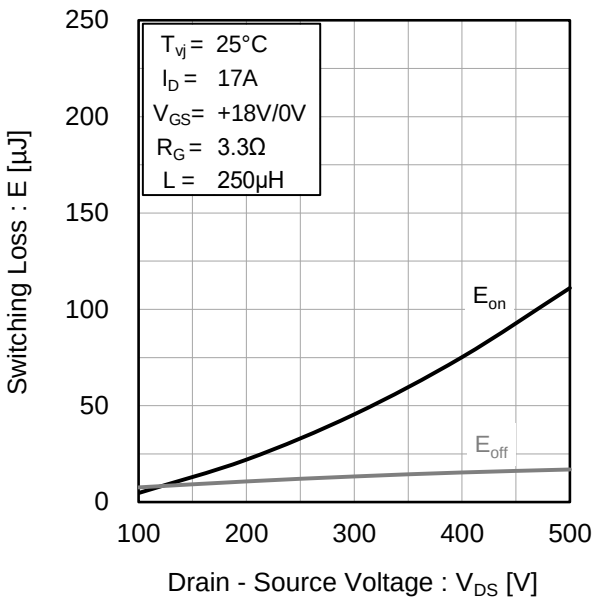


Fig.22 Typical Switching Loss vs. Drain Current

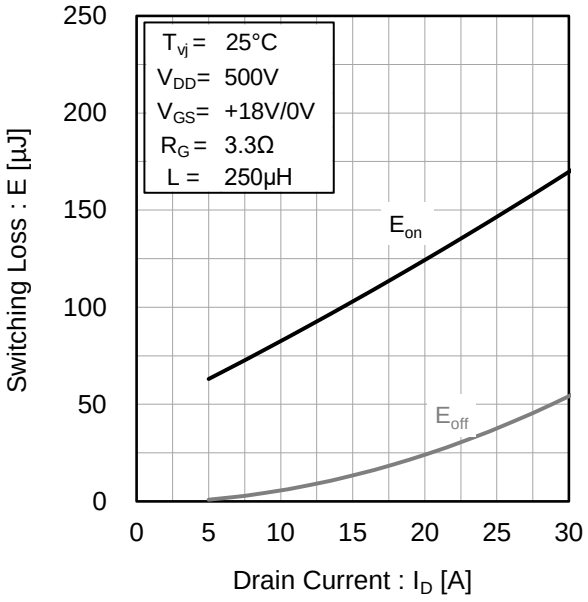
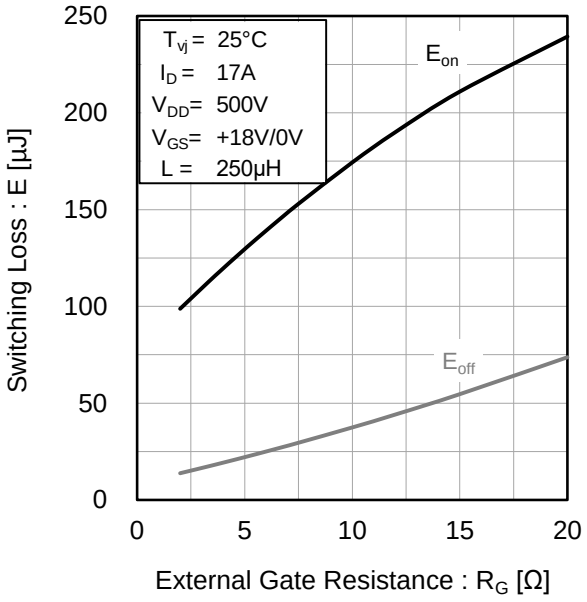


Fig.23 Typical Switching Loss vs. External Gate Resistance



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●Measurement circuits and waveforms

Fig.1-1 Gate Charge Measurement Circuit

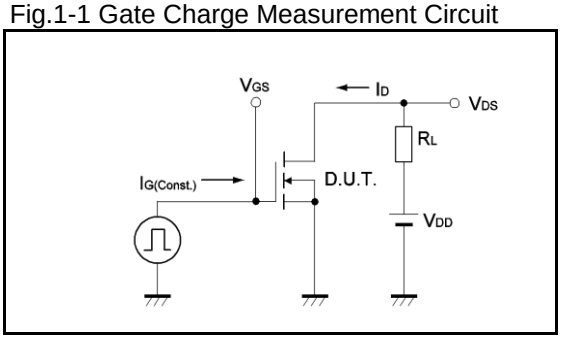


Fig.1-2 Gate Charge Waveform

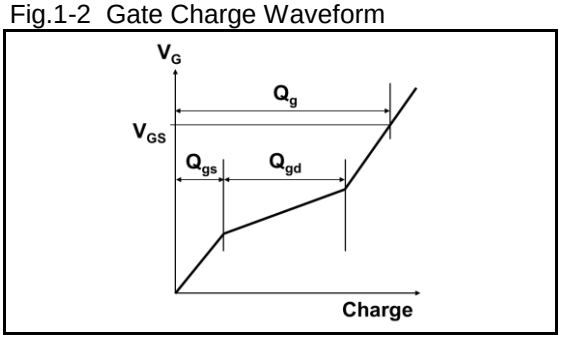


Fig.2-1 Switching Characteristics Measurement Circuit

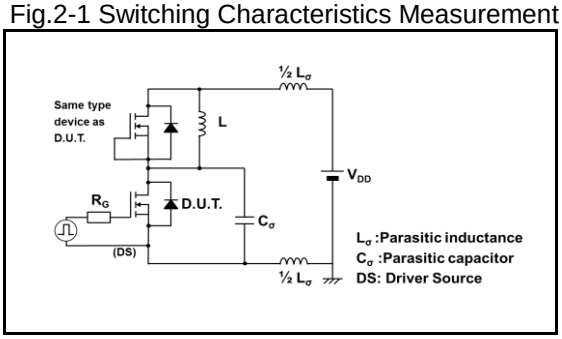


Fig.2-2 Waveforms for Switching Time

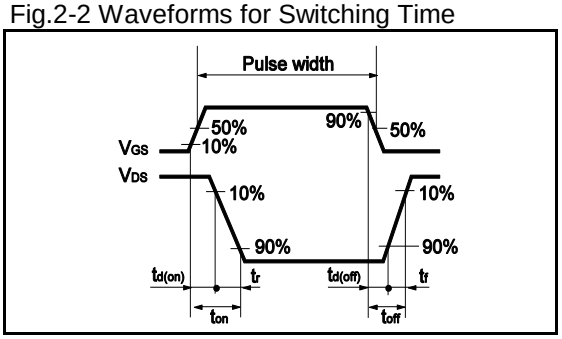


Fig.2-3 Waveforms for Switching Energy Loss

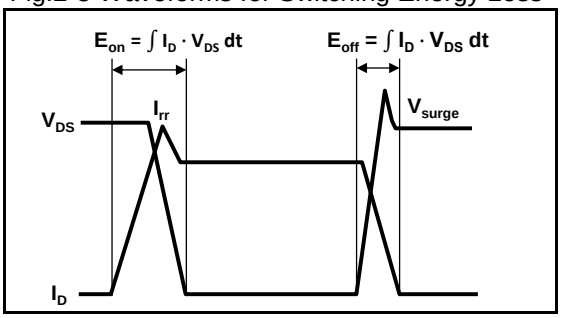


Fig.3-1 Reverse Recovery Time Measurement Circuit

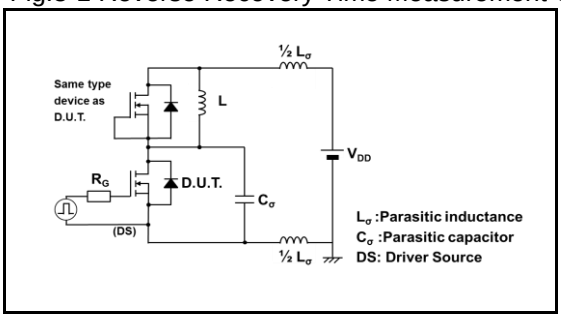
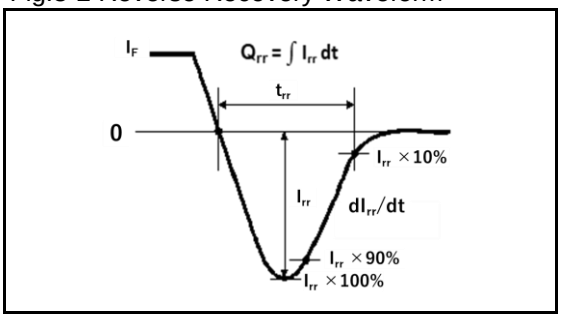


Fig.3-2 Reverse Recovery Waveform



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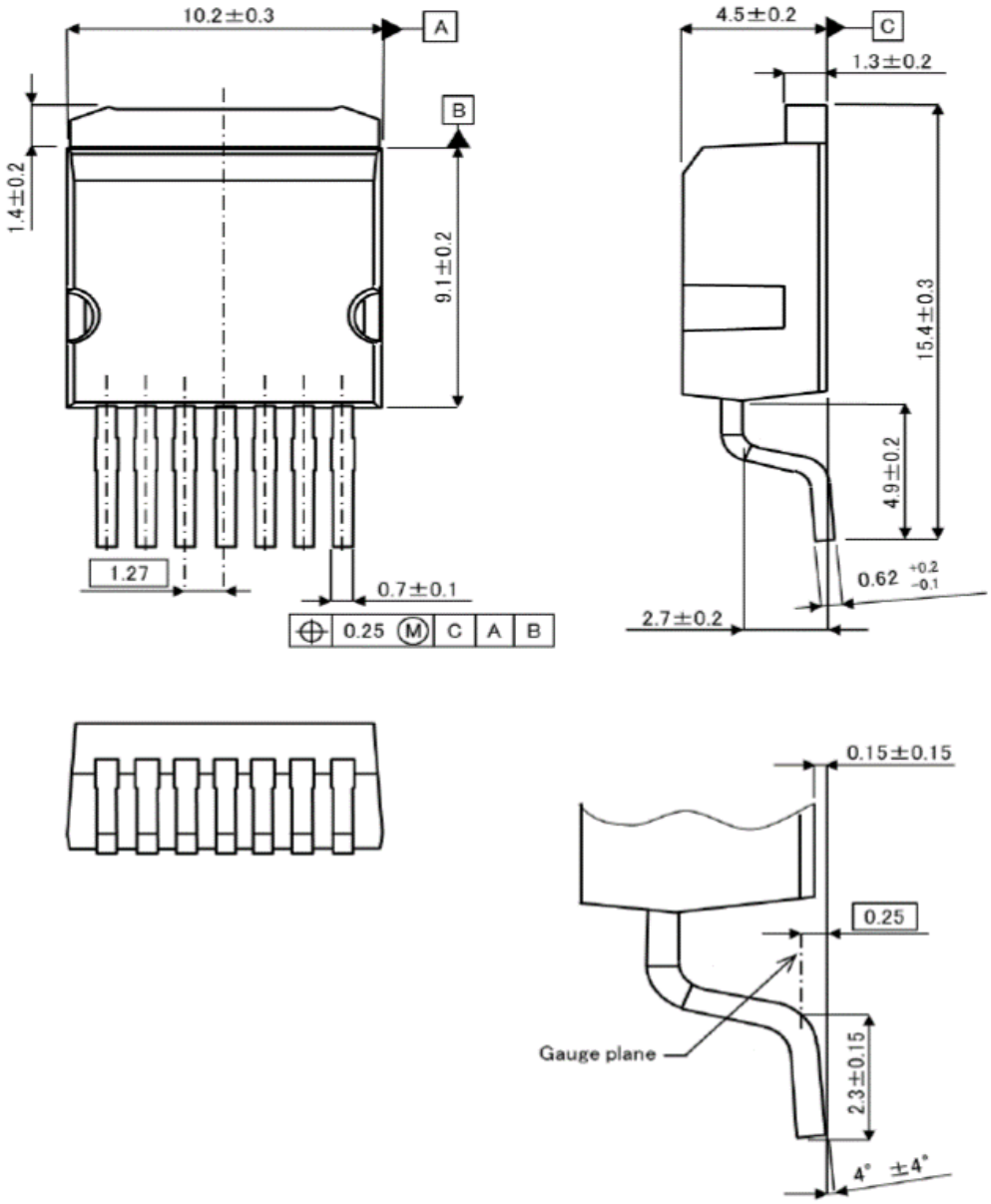
●Package Dimensions



Unit: mm

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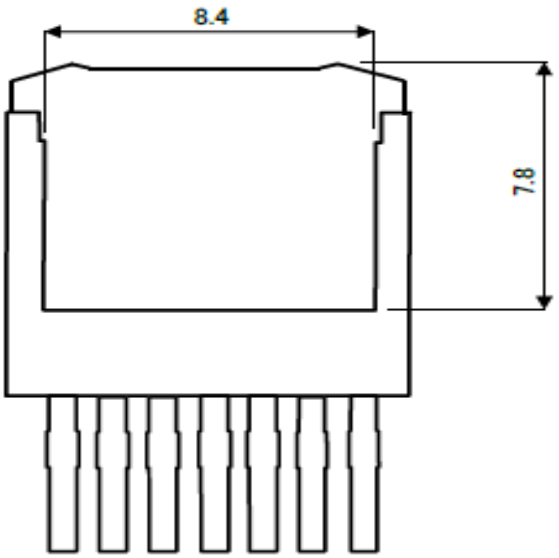
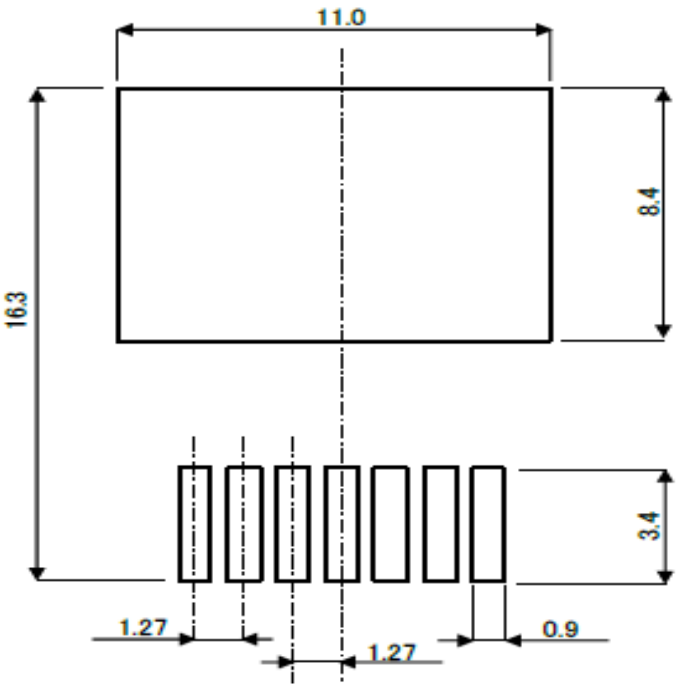


RECOMMENDED FOOTPRINT DIMENSIONS



Unit: mm

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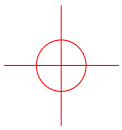
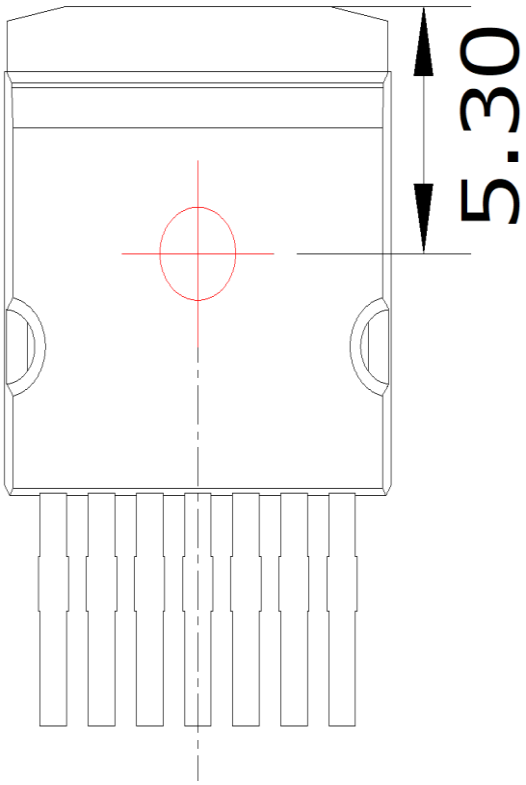
●Die Bonding Layout



: Die position



・Front view of the packaging.

・Dimensions are design values.

・If the heat sink is to be installed, it should be in contact with the die bonding point.

Unit: mm

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Notes

1) The information contained herein is subject to change without notice.

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ROHM SEMICONDUCTOR

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